Series AXP-100 B

100 W Power Resistor with four wire terminals, version B for enforced mechanical stability



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The new design with its non-inductive thick film Metal Oxide Technology prevents potential problems with clearance and creeping distance from terminal to base plate by means of flexible connecting leads.

This unique design allows you to use this elements in the following areas: variable speed drives, power supplies, control devices, telecommunications, robotics, motor controls and other switching devices.

Features

- 1x 100 W / 2x 38 W / 3x 17 W operating power
- Non-Inductive design
- ROHS compliant
- Materials in accordance with UL 94 V-0



Technical Specifications

Resistance value	$1 \Omega \leq 1 M\Omega$
Resistance tolerance	±1 % to ±10 %
Temperature coefficient	± 50 ppm/°C to ± 250 ppm/°C (at $+85^{\circ}$ C ref. to $+25^{\circ}$ C)
Power rating	up to 100 W at 85°C bottom case temperature (see configurations)
Maximum working voltage	$500\ V$ (up to 1,500 V DC on special request = "S"-version)
Short time overload	1,5x rated power for 10 sec, $\Delta R = 0.4\%$ max. (for conf. 1, 2 and 3)
Electric strength voltage	5 kV DC (3 kV AC, higher values on special request) between terminal and case
Internal electric strength between R1 & R2	5 kV DC
Working temperatur range	-55°C to +155°C
Mounting - torque	1.0 Nm to 1.2 Nm
Standard cable length	100 mm (other lengths on special request)
Standard cable type	PVC 0,75 mm², 20-AWG black
Weight	~22 g

Suggested Mounting Procedure:

- 1.) Position component and press down by hand
- 2.) Fix both mounting screws (M4) with 0.1 to 0.2 Nm torque
- 3.) Apply final torque to mounting screws of 1.0 to 1.2 \mbox{Nm}

100 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 | 150 |

Derating (thermal resist.) AXP-100 B: 1.42 W/K (0.70 K/W) (for conf. 1, 2 and 3)

Best results can be reached by using a thermal transfer compound with a heat conductivity of at least 1 W/mK. The flatness of the cooling plate must be better than 0.05 mm overall. Surface roughness should not exceed 6.4 μm .

How to make a request

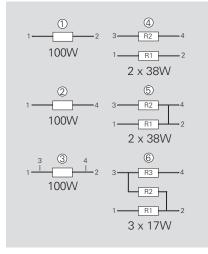
AXP-Configuration B_Ohmic Value_ Tolerance

For example:

AXP-1 B 2K 10% or AXP-4 B 2x50R 5%

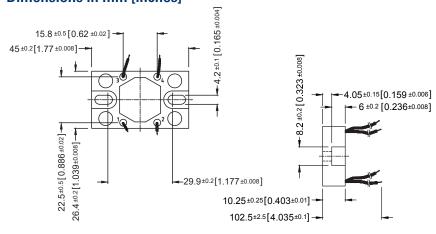
Example for higher working voltage: AXP-1-B-S $55K\ 5\%$

Configurations (P / package)



Version 5: ohmic value between contact 2 and 4 = $3m\Omega$

Dimensions in mm [inches]



Boreholes distance from min. 30.0 mm to max. 37.0 mm

The above spec. sheet features our standard products. For further options please contact our local EBG representative or contact us directly.

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